

CBR-SMD RF COG, Ceramic, 3.9 pF, +/-0.1 pF, 50 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0201



| Dimensions |                  |
|------------|------------------|
| Chip Size  | 0201             |
| L          | 0.6mm +/-0.03mm  |
| W          | 0.3mm +/-0.03mm  |
| T          | 0.3mm +/-0.03mm  |
| B          | 0.15mm +/-0.05mm |

| Packaging Specifications |                          |
|--------------------------|--------------------------|
| Packaging:               | T&R, 180mm, Plastic Tape |
| Packaging Quantity:      | 15000                    |

| General Information |  |
|---------------------|--|
| Series:             | CBR-SMD RF COG                                 |
| Style:              | SMD Chip                                       |
| Description:        | SMD, Fixed, RF, Ultra High Q, Low ESR, Class I |
| Features:           | Ultra High Q, Low ESR, Class I                 |
| RoHS:               | Yes  |
| Termination:        | Tin  |
| Marking:            | No   |
| AEC-Q200:           | No   |
| Notes:              | Solder Reflow Only.                            |
| Shelf Life:         | 78 Weeks                                       |
| MSL:                | 1  |

| Specifications                   |                     |
|----------------------------------|---------------------|
| Capacitance:                     | 3.9 pF              |
| Capacitance Tolerance:           | +/-0.1 pF           |
| Voltage DC:                      | 50 VDC              |
| Dielectric Withstanding Voltage: | 125 VDC             |
| Temperature Range:               | -55/+125°C          |
| Temperature Coefficient:         | COG                 |
| Aging Rate:                      | 0% Loss/Decade Hour |
| Insulation Resistance:           | 10 GOhms            |
| Quality Factor:                  | 478                 |